PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
William J. Armstrong	06/20/2011
John M. Borkenhagen	06/06/2011
Martin J. Crippen	06/06/2011
Dhruv M. Desai	06/06/2011
David R. Engebretsen	06/20/2011
Philip R. Hillier III	06/07/2011
William G. Holland	06/07/2011
James E. Hughes	06/03/2011
James A. O'Connor	06/03/2011
Steven M. Tri	06/20/2011

RECEIVING PARTY DATA

Name:	International Business Machines Corporation	
Street Address:	New Orchard Road	
City:	Armonk	
State/Country:	NEW YORK	
Postal Code:	10504	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13177639

CORRESPONDENCE DATA

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Correspondent Name: IBM Corporation

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PATENT

REEL: 026564 FRAME: 0543

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Address Line 2: Dept. 917 Address Line 4: Rochester, MINNESOTA 55901 ATTORNEY DOCKET NUMBER: ROC920100191US1 NAME OF SUBMITTER: William J. McGinnis Total Attachments: 12 source=ROC920100191US1_SignedAssignments#page1.tif source=ROC920100191US1_SignedAssignments#page2.tif source=ROC920100191US1_SignedAssignments#page3.tif source=ROC920100191US1_SignedAssignments#page4.tif source=ROC920100191US1_SignedAssignments#page5.tif source=ROC920100191US1_SignedAssignments#page6.tif source=ROC920100191US1_SignedAssignments#page7.tif

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PATENT REEL: 026564 FRAME: 0544

ASSIGNMENT

Whereas, the undersigned Inventor(s) has/have made certain inventions, improvements and discoveries (herein referred to as the "Invention") in:

and further identified by the IBM Docket Number provided above in the header of this Assignment, for

Title of the Invention: REDUCING IMPACT OF A SWITCH FAILURE IN A SWITCH FABRIC VIA SWITCH CARDS

which an application for a United States Patent was executed concurrently herewith or was filed having:		
Application No.:	(insert series code /serial number here if/when available)	
ousiness at Armonk, New York (herein refer	Corporation, a corporation of New York having a place of red to as "IBM"), desires to acquire, and each undersigned worldwide right, title, and interest in and to the Invention and patents directed thereto;	

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned Inventor ("ASSIGNOR") hereby sells, assigns, and otherwise transfers to IBM (the "ASSIGNEE"), its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned Inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to IBM, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by IBM, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned Inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in IBM, its successors, legal representatives, and assigns, whenever requested by IBM, its successors, legal representatives, or assigns.

Each undersigned Inventor acknowledges their prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to IBM and is unaware of any reason why they may not have the full and unencumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. Each undersigned Inventor also hereby grants IBM, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent Application Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

[Inventor Signature Page(s) Follows]

Page 1 of 4

Executed by Inventor 1		
Signature:	William J. Armstrong Date: 6/20/2011	
	Executed by Inventor 2	
Signature:	John M. Borkenhagen	
	Executed by Inventor 3	
Signature:	Martin J. Crippen	
Executed by Inventor 4		
Signature: _	Dhruy M. Desai	

Page 2 of 4

Executed by Inventor 5			
Signature:	David R. Engebretsen		
	Executed by Inventor 6		
Signature:	Philip R. Hillier, III		
	Executed by Inventor 7		
Signature:	William G. Holland		
-	Executed by Inventor 8		
Signature:	Date: Date:		

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	Executed by Inventor 9	
Signature: _	Date:	
	James A. O'Connor	
	↑ Executed by Inventor 10	
Signature: _	Date: 6 00 Steven M. Tri	

ASSIGNMENT

Whereas, the undersigned Inventor(s) has/have made certain inventions, improvements and discoveries (herein referred to as the "Invention") in:

Title of the Invention: REDUCING IMPACT OF A SWITCH FAILURE IN A SWITCH FABRIC VIA SWITCH CARDS

and further identified by the IBM Docket Number provided above in the header of this Assignment, for which an application for a United States Patent was executed concurrently herewith or was filed having:

Application No.:

(insert series code /serial number here if/when available)

Whereas, International Business Machines Corporation, a corporation of New York having a place of business at Armonk, New York (herein referred to as "IBM"), desires to acquire, and each undersigned Inventor desires to grant to IBM, the entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned Inventor ("ASSIGNOR") hereby sells, assigns, and otherwise transfers to IBM (the "ASSIGNEE"), its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned Inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to IBM, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by IBM, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned Inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in IBM, its successors, legal representatives, and assigns, whenever requested by IBM, its successors, legal representatives, or assigns.

Each undersigned Inventor acknowledges their prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to IBM and is unaware of any reason why they may not have the full and unencumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. Each undersigned Inventor also hereby grants IBM, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent Application Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

[Inventor Signature Page(s) Follows]

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Executed by Inventor 1			
Signature:	William J. Armstrong		
	Executed by Inventor 2		
Signature:	John M. Borkenhagen		
	Executed by Inventor 3		
Signature:	Martin J. Crippen Date: 6/6/2011 Martin J. Crippen		
	Executed by Inventor 4		
Signature:	Dhruv M. Desai		

Page 2 of 4

	Executed by Inventor 5
Signature: David R. Engebretsen	Date:
	Executed by Inventor 6
Signature: Philip R. Hillier, III	Date:
	Executed by Inventor 7
Signature: William G. Holland	Date: 6/7/201/
	Executed by Inventor 8
Signature: James E. Hughes	gher Date: 6/3/2011

Page 3 of 4

		Executed by Inventor 9	
Signature:		Date:	_
	James A. O'Connor		
		Executed by Inventor 10	
Signature:		Date:	_
	Steven M. Tri		

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1839782_1

USRTPPATENT PAGE. 05 REEL: 026564 FRAME: 0552

ASSIGNMENT

Whereas, the undersigned Inventor(s) has/have made certain inventions, improvements and discoveries (herein referred to as the "Invention") in:

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Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned Inventor ("ASSIGNOR") hereby sells, assigns, and otherwise transfers to IBM (the "ASSIGNEE"), its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned Inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to IBM, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by IBM, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned Inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in IBM, its successors, legal representatives, and assigns, whenever requested by IBM, its successors, legal representatives, or assigns.

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Date			
Martin J. Crippen			
Executed by Inventor 4	_		
Date:			
Dhruv M. Desai			
	Date: William J. Armstrong Executed by Inventor 2 Date: John M. Borkenhagen Executed by Inventor 3 Date: Martin J. Crippen Executed by Inventor 4		

Page 2 of 4

Executed by Inventor 5				
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Signature	Date:			
	David R. Engebretsen			
	Executed by Inventor 6			
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Signature:	Date:			
	Philip R. Hillier, III			
	Executed by Inventor 7			
Signature:	Date:			
	William G. Holland			
	Executed by Inventor 8			
Signature	Date:			
Digilature	James E. Hughes			
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Page 3 of 4

Executed by Inventor 9			
Signature: Jam. Q. O'Connor James A. O'Connor	Date:		
Executed by	y Inventor 10		
Signature:Steven M. Tri	Date:		

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RECORDED: 07/08/2011